

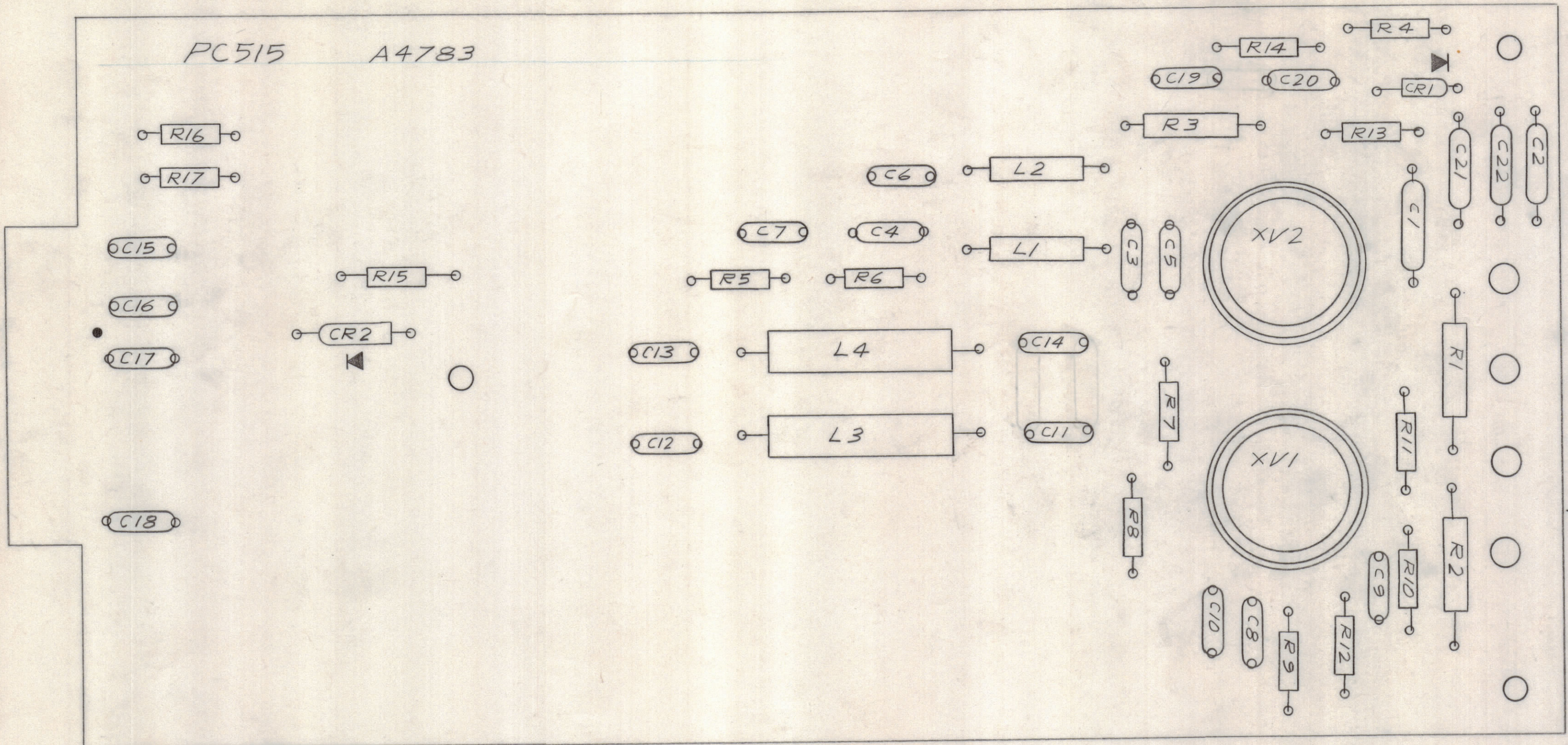
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					REVISIONS		
E.M.N.NO	DRAFT	CHKD	ZONE	LTR	DESCRIPTION	DATE	APPROVED
	KD			X	EXPERIMENTAL RELEASE	2-24-70	
	(1)			Ø	ORIGINAL RELEASE FOR PRODUCTION	2/26/70	



**ASSEMBLY NOTES**

1. TO MOUNT COMPONENTS ; INSERT LEAD THROUGH PLATED THRU HOLES.
2. CAUTION WHEN APPLYING HEAT AND SOLDER TO LEAD AND FOIL
3. CLEAN AND INSPECT AS PER TMC SPEC S 676
4. FOR ELECTRICAL COMPONENT PART NUMBERS REFER TO NPL A 4783
5. USE SYMBOL NUMBERS FOR ASSEMBLY REFERENCE .

**SPARE PARTS USE ONLY**

QTY. REQ.	ITEM	PART NO.	DESCRIPTION	SYMBOL
X	2	BS 100	SOLDER TIN ALLOY	
1	1	PC515	PRINTED CIRCUIT BOARD	

BUDETTI LIST OF MATERIAL			
FINAL APPROVAL	DATE	<b>THE TECHNICAL MATERIEL CORP.</b> MAMARONECK, NEW YORK  ASS'Y PRINTED CIRCUIT BD.	
MECH. DES.	DATE		
ELECT. DES.	DATE		
CHECKED	DATE		
DRAWN	DATE		
SIZE	CODE IDENT NO.	DWG NO.	ISSUE
C	82679	A 4783	Ø

QTY / UNIT	MODEL USED ON	ASS'Y NO.
	PALA-10K	AX5084
APPLICATION		
	CODE	
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MATERIAL		
FINISH		

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